

TLP523, TLP523-2, TLP523-4

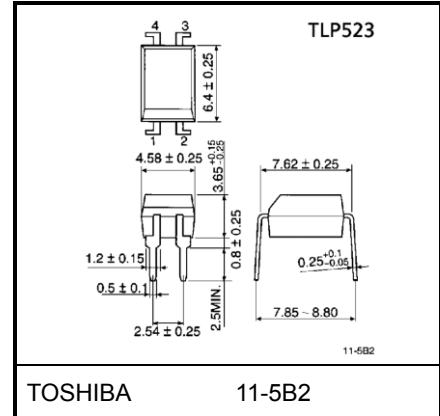
Programmable Controllers
 DC-Output Module
 Solid State Relay

The TOSHIBA TLP523, -2 and -4 consist of an infrared emitting diode coupled with a silicon, Darlington connected, phototransistor which has an integral base-emitter resistor to optimize switching speed and elevated temperature characteristics.

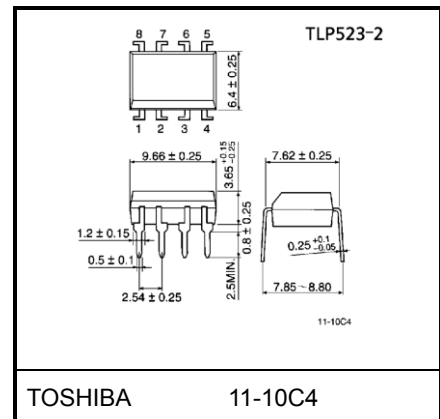
The TLP523-2 offers two isolated channels in an eight lead plastic DIP package, while the TLP523-4 provides four isolated channels per package.

- Current transfer ratio: 500 % (min) (IF = 1 mA)
- Isolation voltage: 2500 Vrms (min)
- Collector-emitter voltage: 55 V (min)
- Leakage current: 10 μ A (max) (Ta = 85°C)
- UL-recognized: UL 1577, File No.E67349
- cUL-recognized :CSA Component Acceptance Service No.5A
 File No.E67349

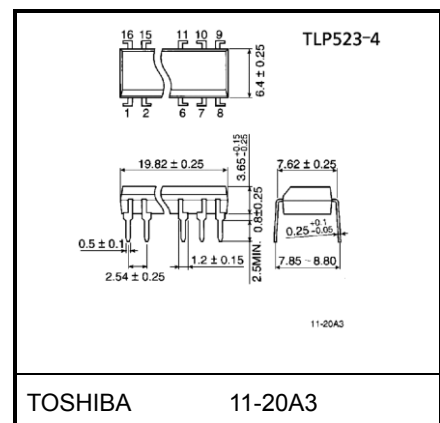
Unit: mm



Weight: 0.26 g (typ.)



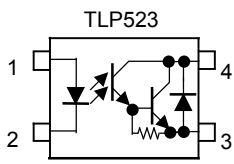
Weight: 0.54 g (typ.)



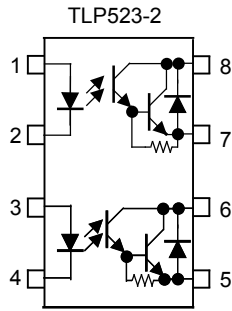
Weight: 1.1 g (typ.)

Start of commercial production
 1984-08

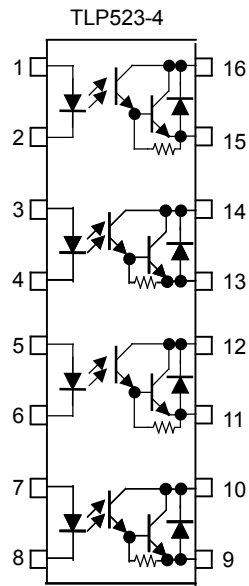
Pin Configurations (top view)



- 1 : Anode
- 2 : Cathode
- 3 : Emitter
- 4 : Collector



- 1, 3 : Anode
- 2, 4 : Cathode
- 5, 7 : Emitter
- 6, 8 : Collector



- 1, 3, 5, 7 : Anode
- 2, 4, 6, 8 : Cathode
- 9, 11, 13, 15 : Emitter
- 10, 12, 14, 16 : Collector

Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating		Unit
			TLP523	TLP523-2 TLP523-4	
LED	Forward current	I _F	60	50	mA
	Forward current derating	ΔI _F /°C	-0.7 (Ta ≥ 39°C)	-0.5 (Ta ≥ 25°C)	mA/°C
	Pulse forward current (100 μs pulse, 100 pps)	I _{FP}	1		A
	Diode power dissipation	P _D	70	60	mW
	Diode power dissipation derating	ΔP _D /°C	-0.8 (Ta ≥ 39°C)	-0.6 (Ta ≥ 25°C)	mW/°C
	Reverse voltage	V _R	5		V
Detector	Collector-emitter voltage	V _{CEO}	55		V
	Emitter-collector voltage	V _{ECO}	0.3		V
	Collector current	I _C	150		mA
	Collector power dissipation (1 circuit)	P _C	150	100	mW
	Collector power dissipation derating (1 circuit) (Ta ≥ 25°C)	ΔP _C /°C	-1.5	-1.0	mW/°C
Operating temperature range		T _{opr}	-55 to 100		°C
Storage temperature range		T _{stg}	-55 to 125		°C
Lead soldering temperature (10 s)		T _{sol}	260		°C
Total power dissipation (1 circuit)		P _T	250	150	mW
Total power dissipation derating (Ta ≥ 25°C) (1 circuit)		ΔP _T /°C	-2.5	-1.5	mW/°C
Isolation voltage (AC, 60 s, R.H. ≤ 60 %) (Note 1)		BV _S	2500		V _{rms}

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Device considered a two terminal device: LED side pins shorted together and detector side pins shorted together.

Recommended Operating Conditions

Characteristics	Symbol	Min	Typ.	Max	Unit
Supply voltage	V _{CC}	—	5	24	V
Forward current	I _F	—	16	20	mA
Collector current	I _C	—	—	40	mA
Operating temperature range	T _{opr}	-25	—	85	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

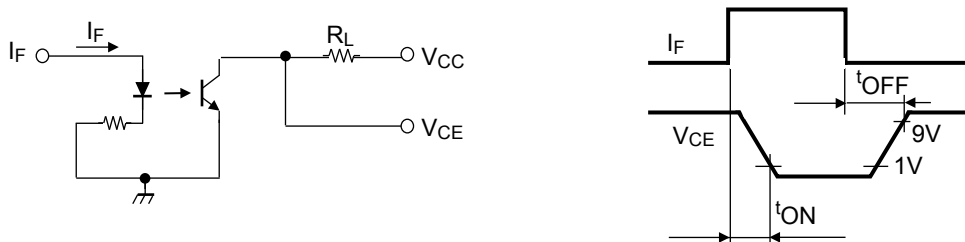
Electrical Characteristics (Ta = 25°C)

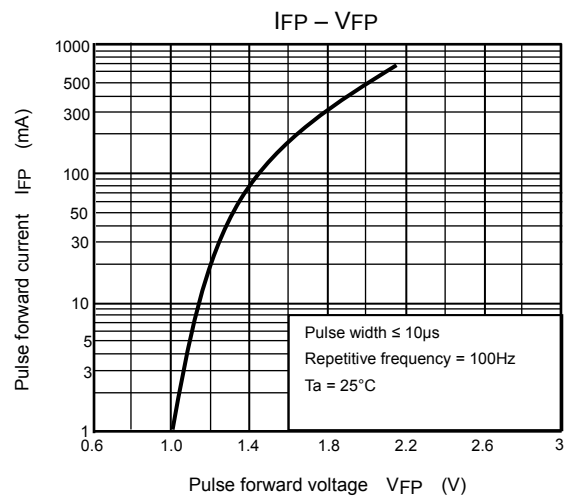
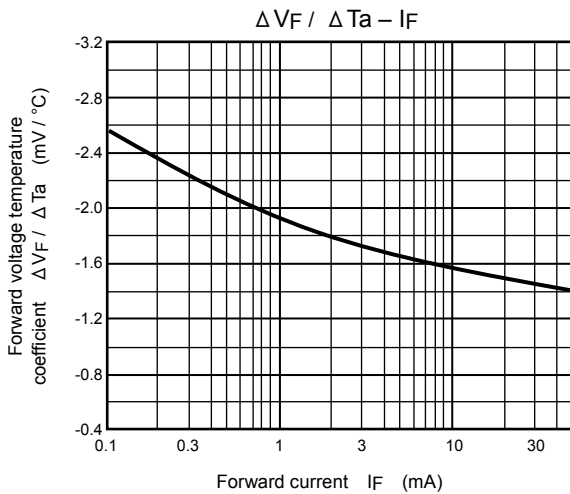
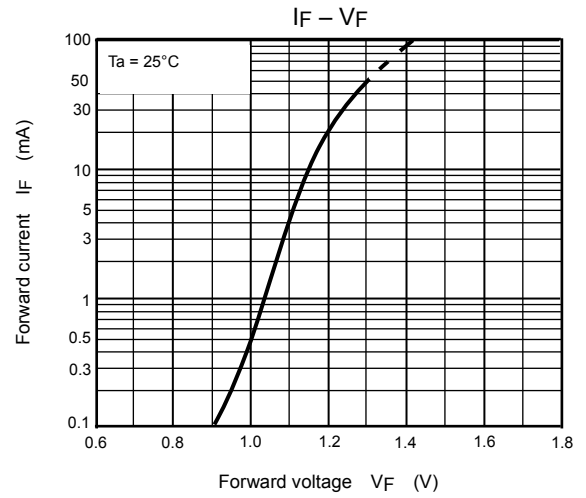
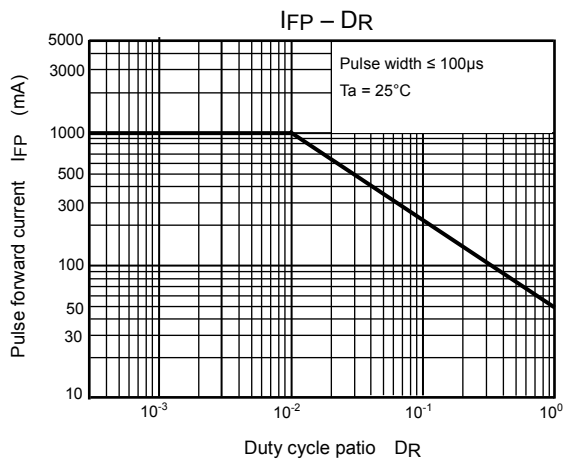
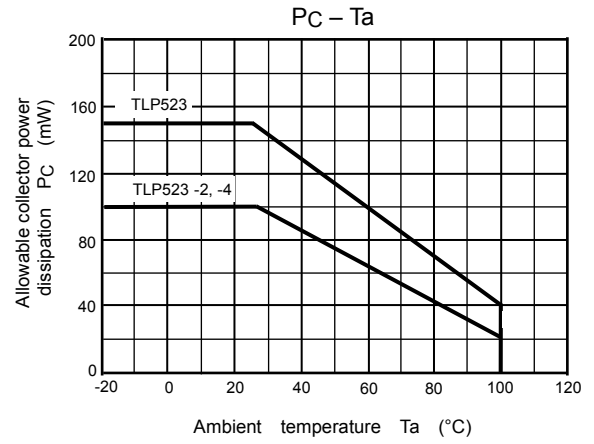
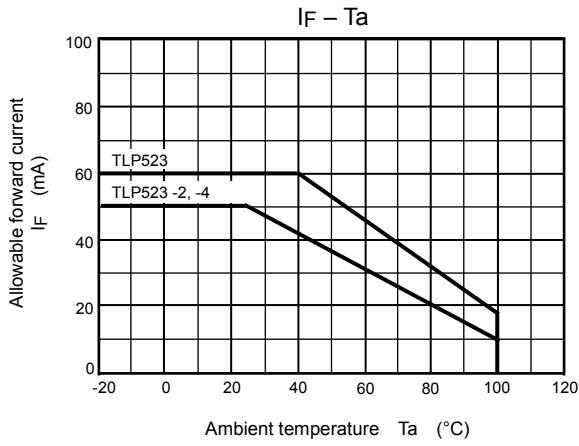
Characteristics		Symbol	Test Condition	Min	Typ.	Max	Unit
LED	Forward voltage	V_F	$I_F = 10 \text{ mA}$	1.0	1.15	1.3	V
	Reverse current	I_R	$V_R = 5 \text{ V}$	—	—	10	μA
	Capacitance	C_T	$V = 0 \text{ V}, f = 1 \text{ MHz}$	—	30	—	pF
Detector	Collector-emitter breakdown voltage	$V_{(BR) \text{ CEO}}$	$I_C = 1 \text{ mA}$	55	—	—	V
	Collector dark current	I_{CEO}	$I_F = 0 \text{ mA}, V_{\text{CE}} = 24 \text{ V}$	—	10	200	nA
			$I_F = 0 \text{ mA}, V_{\text{CE}} = 24 \text{ V}, T_a = 85 \text{ }^\circ\text{C}$	—	0.5	10	μA
	Capacitance collector to emitter	C_{CE}	$V = 0 \text{ V}, f = 1 \text{ MHz}$	—	10	—	pF
Coupled	Current transfer ratio	I_C/I_F	$I_F = 1 \text{ mA}, V_{\text{CE}} = 1 \text{ V}$	500	2000	—	%
	Collector-emitter saturation voltage	$V_{\text{CE(sat)}}$	$I_C = 50 \text{ mA}, I_F = 10 \text{ mA}$	—	—	1	V
	Capacitance input to output	C_S	$V_S = 0 \text{ V}, f = 1 \text{ MHz}$	—	0.8	—	pF
	Isolation resistance	R_S	$V_S = 500 \text{ V}, \text{R.H.} \leq 60 \%$	5×10^{10}	10^{14}	—	Ω

Switching Characteristics (Ta = 25°C)

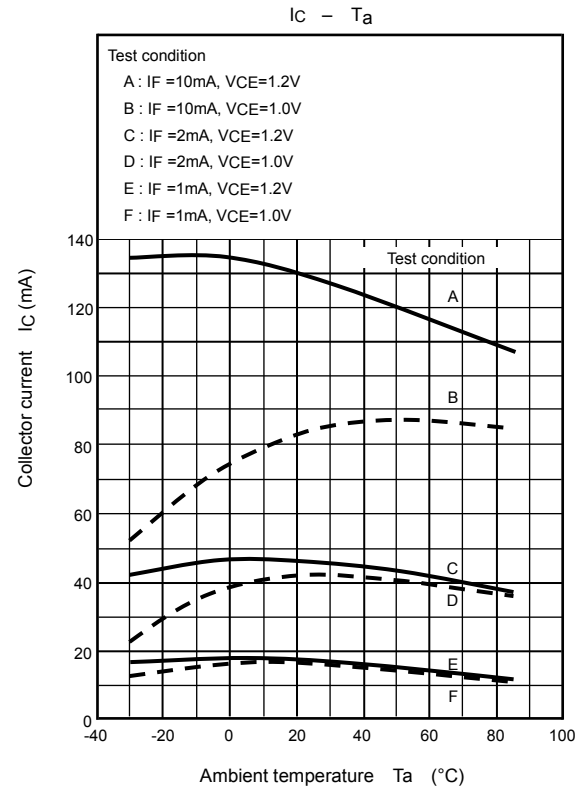
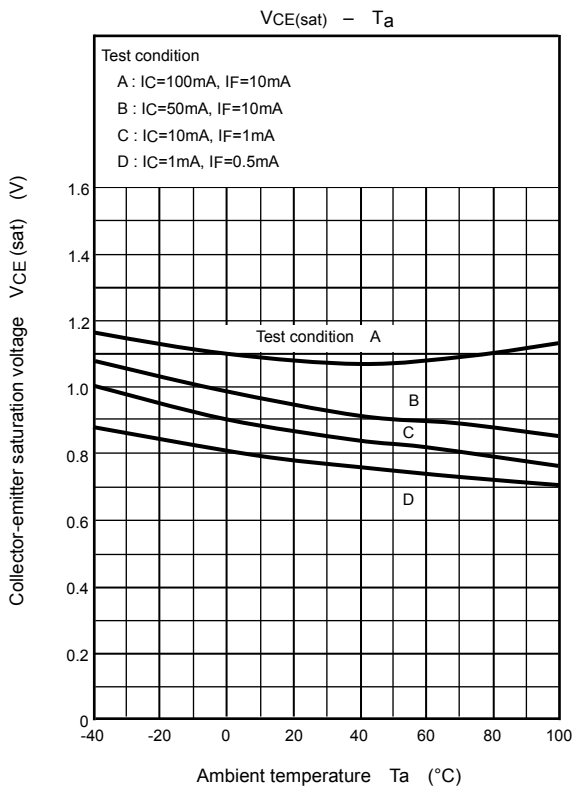
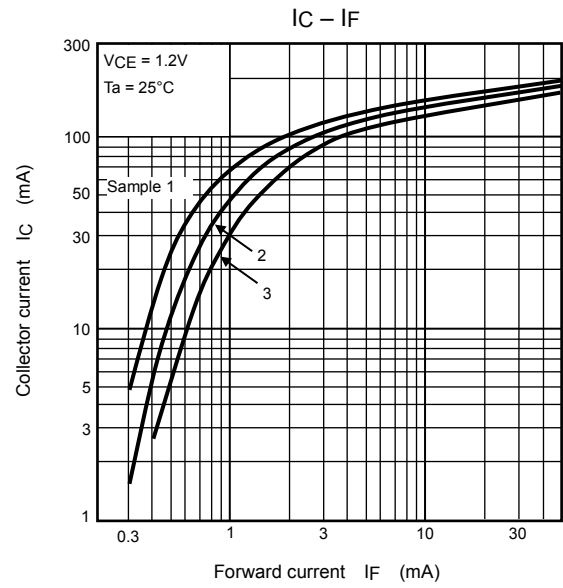
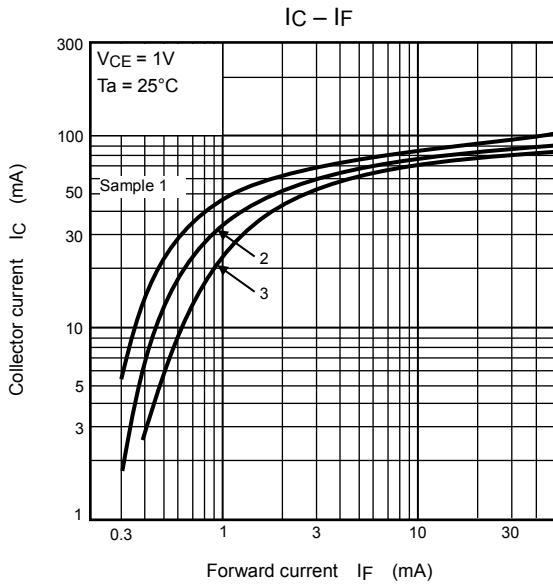
Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Turn-on time	t_{ON}	$V_{\text{CC}} = 10 \text{ V}, R_L = 180 \Omega$ (Fig. 1)	—	3	—	μs
Turn-off time	t_{OFF}	$I_F = 16 \text{ mA}$	—	80	—	μs

Fig. 1: Switching Time Test Circuit

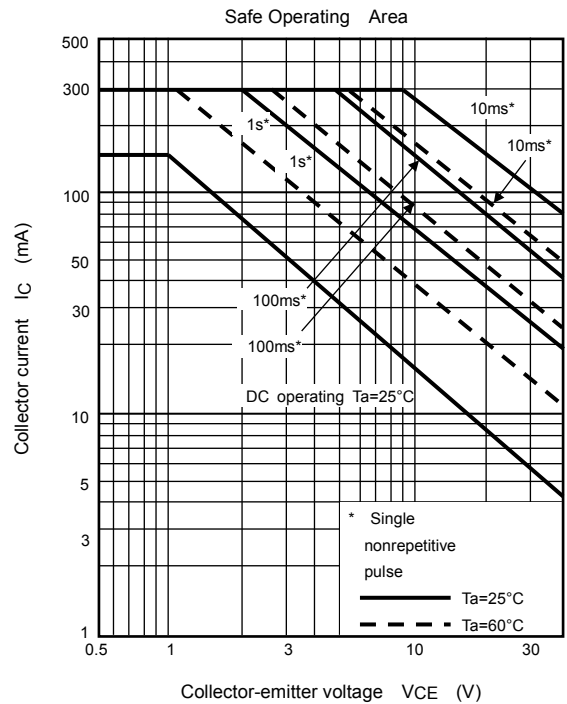
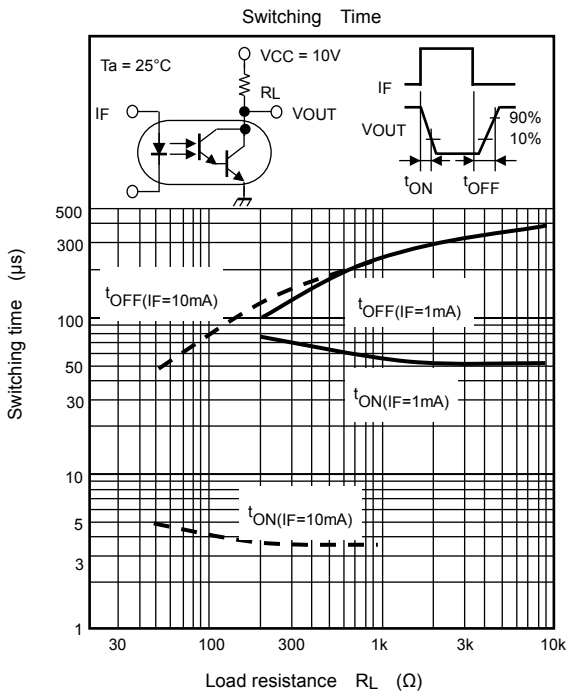
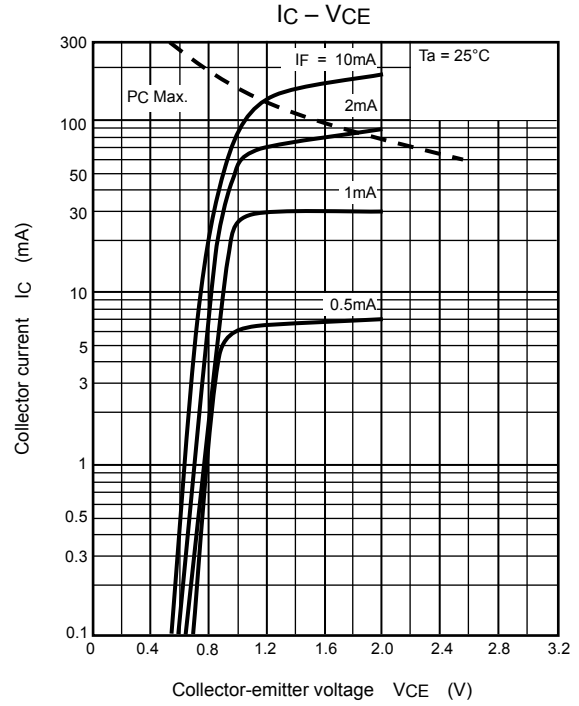
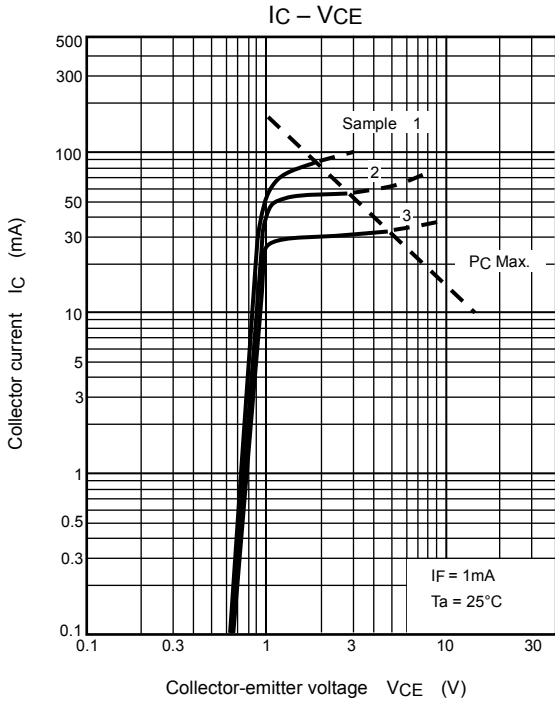




NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



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